

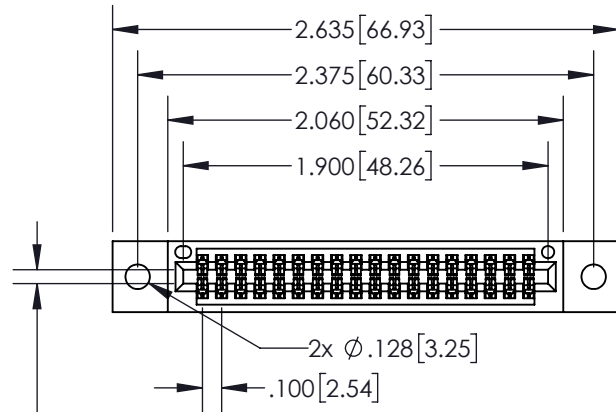
Contact Dimensions:
560-Extender Board Bend (Code 523 Contacts)
 See Sheet 2 for Contact Code 555, 556, 558, 559, 560 Dimensions

THIS IS A C.A.D. GENERATED DRAWING
 DO NOT MAKE MANUAL REVISIONS TO MASTER

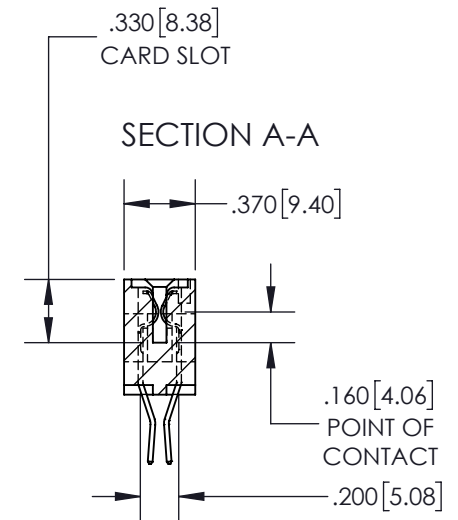
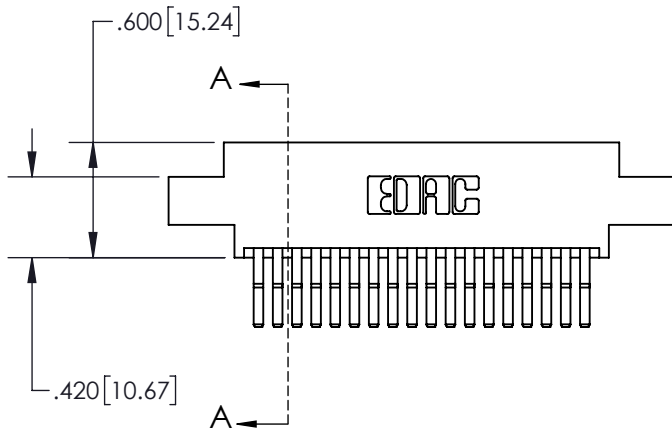


ISSUE NUMBER

ORIGINAL



CARD SLOT ACCEPTS
 .054" [1.37] TO .070" [1.78]
 THICK PCB



- INSULATOR MATERIAL: THERMOPLASTIC, UL 94V-0
- CONTACT MATERIAL: COPPER TIN ALLOY
- CONTACT PLATING: GOLD ON THE MATING AREA, TIN PLATING ON THE CONTACT TAILS, NICKEL UNDERPLATE

845/895 SERIES HIGH TEMP CARD EDGE CONNECTOR
 PART NUMBER: 895-036-560-802

ACAD REFERENCE NO. 845-ENG-MASTER

DRAWN: R.STA.MONICA DATE: MAY.16/2017

CHECKED: DATE:

SCALE: 1:1 SHEET 1 OF 2

DRAWING NUMBER 845-ENG-MASTER ISSUE 1

EDAC EDAC INC
 TORONTO, ONTARIO
 CANADA
 YOUR CONNECTION TO QUALITY & SERVICE

THESE DRAWINGS AND SPECIFICATIONS ARE THE PROPERTY OF EDAC INC. AND SHALL NOT BE REPRODUCED, OR COPIED OR USED AS THE BASIS FOR THE MANUFACTURE OR SALE OF APPARATUS WITHOUT WRITTEN PERMISSION.

THIS IS A C.A.D. GENERATED DRAWING
DO NOT MAKE MANUAL REVISIONS TO MASTER.



ISSUE NUMBER

ORIGINAL



Contact Code 555



Contact Code 556



Contact Code 558



Contact Code 559



Contact Code 560

- INSULATOR MATERIAL: THERMOPLASTIC POLYESTER, UL 94V-0
- DAP MATERIAL AVAILABLE UPON REQUEST
- CONTACT MATERIAL: COPPER ALLOY
- CONTACT PLATING: GOLD ON THE MATING AREA, TIN PLATING ON THE CONTACT TAILS, NICKEL UNDERPLATE

**845/895 SERIES HIGH TEMP CARD EDGE CONNECTOR
CONTACT CODE 555,556,558,559,560 DIMENSIONS**



THESE DRAWINGS AND SPECIFICATIONS ARE THE PROPERTY OF EDAC INC. AND SHALL NOT BE REPRODUCED, OR COPIED OR USED AS THE BASIS FOR THE MANUFACTURE OR SALE OF APPARATUS WITHOUT WRITTEN PERMISSION.

ACAD REFERENCE NO. 845-ENG-MASTER	
DRAWN: R.STA.MONICA	DATE: MAY.16/2017
CHECKED:	DATE:
SCALE: 1:1	SHEET 2 OF 2
DRAWING NUMBER 845-ENG-MASTER	ISSUE 1